- Full-Carry Look-Ahead Across the Four Rits
- Systems Achieve Partial Look-Ahead Performance with the Economy of Ripple Carry
- Supply Voltage and Ground on Corner Pins to Simplify P-C Board Layout

TYPICAL ADD TIMES

	TWO	TWO	TYPICAL POWER
	8-BIT	16-BIT	DISSIPATION
TYPE	WORDS	WORDS	PER ADDER
'283	23ns	43ns	310 mW
'LS283	25ns	45ns	95 mW
'S283	15ns	30ns	510 mW

description

The '283 and 'LS283 adders are electrically and functionally identical to the '83A and 'LS83A, respectively; only the arrangement of the terminals has been changed. The 'S283 high performance versions are also functionally identical.

These improved full adders perform the addition of two 4-bit binary words. The sum (Σ) outputs are provided for each bit and the resultant carry (C4) is obtained from the fourth bit. These adders feature full internal look-ahead across all four bits generating the carry term in ten nanoseconds, typically, for the '283 and 'LS283, and 7.5 nanoseconds for the 'S283. This capability provides the system designer with partial look-ahead performance at the economy and reduced package count of a ripple-carry implementation.

The adder logic, including the carry, is implemented in its true form. End around carry can be accomplished without the need for logic or level inversion.

Series 54, Series 54LS, and Series 54S circuits are characterized for operation over the full temperature range of -55°C to 125°C. Series 74, Series 74LS, and Series 74S circuits are characterized for 0°C to 70°C operation.

SN54283, SN54LS283... J OR W PACKAGE SN54S283... J PACKAGE SN74283... N PACKAGE SN74LS283, SN74S283... D OR N PACKAGE (TOP VIEW)

Σ2 1 1 16 VCC

B2 2 15 B3

A2 3 14 A3

Σ1 4 13 Σ3

A1 5 12 A4

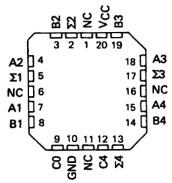
B1 6 11 B4

SN54LS283, SN54S283 . . . FK PACKAGE (TOP VIEW)

CO

GND

10 🔲 Σ4



NC - No internal connection

FUNCTION TABLE

						OUT	PUT		
1				WHE	N		WHE	N	
1	INF	TU		C0 =	٧ ا		C0 =	н/	
1				/	/ W	HEN		/ W	HEN
				4		2 - L	/		2 - H
A1/	B1/	A2/	B2/	٤1/	Σ2/	C2/	Σ1/	Σ2/	C2/
Z.A.	V 83	/ A4	/ 84	∠ Σ3	<u>Σ4</u>	<u> </u>	<u> </u>	24	/ C4
L	L	L	L	L	L	L	н	,L	L
н	L	L	L	н	L	L	L	н	L
L	H	L	L	н	L	L	L	н	L
H	н	L	L	L	н	L.	н	н	L
L	L	н	L	L	н	L	н	н	L
Н	١.	н	L	н	н	L	L	L	н
L	н	н	L	н	н	L	L	L	н
H	Н	н	L	L	L	н	н.	L	н
L	L	L	н	L	н	L	н	44	L
H	1 L	L	Н	н	н	L	L	L	н
L	н	L	н	H	н	L	L	L	н
Н	Н	L	н	L	L	н	н	L	н
L	L	Н	н	L	L	н	н	L	н
н	L	н	н	н	L	н	L	Н	н
L	н	н	н	н	L	н	L	Н	н
Н	Н	Н	н	L	н	н	н	н	Н

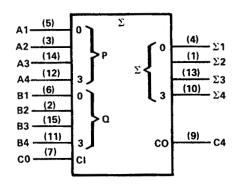
H = high level, L = low level

NOTE: Input conditions at A1, B1, A2, B2, and C0 are used to determine outputs Σ1 and Σ2 and the value of the internal carry C2. The values at C2, A3, B3, A4, and B4 are then used to determine outputs Σ3, Σ4, and C4.



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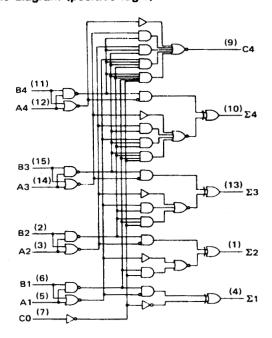
logic symbol†



 $^{^{\}dagger}\text{This}$ symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

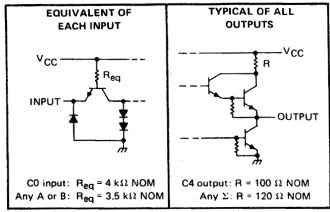
Pin numbers shown are for D, J, N, and W packages.

logic diagram (positive logic)

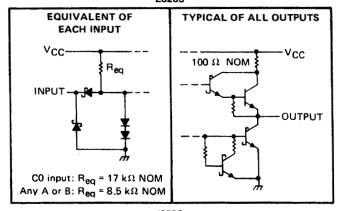


Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



'LS283



EQUIVALENT OF EACH INPUT

VCC

2.8 k\(\Omega\) NOM

INPUT

OUTPUT

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .																				7V
Input voltage: '283, 'S283								٠.												5.5V
'LS283																				7V
Interemitter voltage (see Note 2) .																				5.5V
Operating free-air temperature range:	SN5	42	83,	SN	541	LS2	283	, S	N5	452	83						5	5°(Cto	125°C
	SN7	42	83,	SN	74	LS2	283	8, S	N7	452	283							0	°C 1	to 70°C
Storage temperature range																	6	5°(C to	150°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter transistor. This rating applies for the '283 and 'S283 only between the following pairs: A1 and B1, A2 and B2, A3 and B3, A4 and B4.



recommended operating conditions

			SN5428	3		SN7428	174283	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply Voltage, VCC		4.5	5	5.5	4.75	5	5.25	V
High level autout august 1	Any output except C4			-800			-800	
High-level output current, IOH	Output C4	·		-400			- 400	μА
Law level autout autout	Any output except C4			16			16	
Low-level output current, IOL	Output C4		,	8			8	mA
Operating free-air temperature, TA		55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAM	ETED	TEST CO	NDITIONS†		SN5428	3		SN7428	3	
	FARAIN	EIEN	1231 CO	NDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input volt	age			2			2			V
VIL	Low-level input volt	age					0.8			0.8	V
VIK	Input clamp voltage		VCC = MIN,	I _I = -12 mA			-1.5			-1.5	V
V _{ОН}	High-level output vo	ltage	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = MAX	2.4	3.6		2.4	3.6	,	v
VOL	Low-level output vo	tage	V _{CC} = MIN, V _{IL} = 0.8 V,			0.2	0.4		0.2	0.4	v
l _l	Input current at ma	ximum	V _{CC} = MAX,	V _I = 5.5 V			1			1	mA
ΉH	High-level input curr	ent	VCC = MAX,	V ₁ = 2.4 V			40			40	μА
IIL	Low-level input curr	ent	V _{CC} = MAX,	V _I = 0.4 V			-1.6			-1.6	mA
los	Short-circuit	Any output except C4	V _{CC} = MAX		-20		-55	-18		55	<u> </u>
.08	output current §	Output C4	1 VCC - WAA		-20		-70	-18		-70	mA ·
¹cc	Supply current		V _{CC} = MAX,	All B low, other inputs at 4.5 V		56			56		
,00	Copply Cullent		Outputs open	All inputs at 4.5 V		66	99		66	110	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER 9	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	СО	A 5			14	21	
tPHL_		Any Σ	C _L = 15 pF, R _L = 400 Ω,		12	21	ns
^t PLH	A _i or B _i	Σ.	See Note 3		16	24	
^t PHL	Λ ₁ Οι Β ₁ ,	Σ_{i}			16	24	ns
tPLH .	· C0	C4			9	14	
^t PHL	1	C4	CL = 15 pF, RL = 780 Ω,		11.	16	ns
^t PLH	A. or B.	i or Bi C4	See Note 3		9	14	
tPHL.	7 7 7 6				11	16	ns

 $[\]P_{tPLH}$ = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

Sonly one output should be shorted at a time.

tpHL = propagation delay time, high-to-low-level output

recommended operating conditions

	S	N54LS2	83	SI	174LS2	83	
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-400			400	μА
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMET		700	T CONDITIO	auc†	SI	154LS2	83	SI	N74LS2	83	····
	PARAMET	EH	1 E 8	ST CONDITIO	NS'	MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	UNIT
VIH	High-level input v	oltage				2			2			V
VIL	Low-level input v	oltage						0.7			0.8	٧
VIK	Input clamp volta	age	V _{CC} = MIN,	1 _j = -18 mA				-1.5			-1.5	٧
Voн	High-level output	voltage	V _{CC} = MIN, I _{OH} = -400 μA		VIL = VIL max,	2.5	3.4		2.7	3.4		v
Voi	Low-level output	voltage	V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	, , ,
VOL	Low-level output	Vortage	VıL = VıL max		IOL = 8 mA					0.35	0.5	V
	Input current at maximum	Any A or B	V MAY	V - 7V				0.2			0.2	
11	input voltage	СО	V _{CC} = MAX,	V = / V				0.1			0.1	mA
1	High-level	Any A or B	V MAY	V -07V				40			40	
ЧН	input current	CO	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μΑ
Ī	Low-level	Any A or B	V _{CC} = MAX,	V. = 0.4.V			-	-0.8			-0.8	
11L	input current	CO	VCC - MAA,	V - 0,4 V				-0.4			-0.4	mA
los	Short-circuit out	out current§	V _{CC} = MAX			-20		-100	-20		-100	mA
					All inputs grounded		22	39		22	39	
Icc	Supply current		V _{CC} = MAX, Outputs open		All B low, other inputs at 4.5 V		19	34		19	34	mA
					All inputs at 4.5 V		19	34		19	34	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{ C}$

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
^t PLH	CO	Any Σ				16	24	
^t PHL		Any 2				15	24	ns
tPLH .	A _i or B _i	2.	1			15	24	
^t PHL	7,0,5,	Σ_{i}	$C_L = 15 pF$,	$R_L = 2 k\Omega$,		15	24	ns
tPLH .	CO	C4	See Note 3			11	17	
tPHL.		<u>س</u>				11	22	ns
[†] PLH	A _i or B _i	C4	1			11	17	
tPHL:	7 7 5 6	~				12	17	ns

[¶]tpLH = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

[§]Only one output should be shorted at a time and duration of the short-circuit should not exceed one second.

tpHL = propagation delay time, high-to-low-level output

recommended operating conditions

			SN54S28	3	1.	SN74S283	3	J
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC		4.5	5	5.5	4.75	5	5.25	V
	Any output except C4			-1			-1	mA
High-level output current, IOH	Output C4			-500			-500	μΑ
	Any output except C4			20			20	
Low-level output current, IOL	Output C4			10			10	
Operating free-air temperature,	TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER			TEST CO	ONDITIONS†	MIN	TYPŤ	MAX	UNIT
VIH	High-level input vo	itage				2			V
VIL	Low-level input vo	ltage						8.0	V
VIK	Input clamp voltag	je		V _{CC} = MIN,	I ₁ = -18 mA			-1.2	v
	11:	-44	SN54S283	V _{CC} = MIN,	V _{1H} = 2 V,	2.5	3.4		T
VOH	High-level output	voitage	SN74S283	V ₁ L = 0.8 V,	I _{OH} = MAX	2.7	3.4		†
VOL	Low-level output v	oltage/		V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = MAX			0.5	v
ħ	Input current at m input voltage	aximum		V _{CC} = MAX,	V _I = 5.5 V			1	mA
[†] ІН	High-level input cu	irrent		V _{CC} = MAX,	V ₁ = 2.7 V			50	μА
IIL	Low-level input cu	rrent		V _{CC} = MAX,	V ₁ = 0.5 V		***************************************	-2	mA
1	Short-circuit	Any outp	ut except C4	1/ - 1/A V		-40		-100	<u> </u>
los	output current§	Output C	4	VCC = MAX		-20		-100	mA mA
loo	Supply current			V _{CC} = MAX,	All B low, other inputs at 4.5 V		80		
¹cc	Supply current			Outputs open	All inputs at 4.5 V		95	160	mA mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	CO	A 53			11	18	
ФНL		Any Σ	$C_{L} = 15 pF$, $R_{L} = 280 \Omega$,		12	18	ns
ФLН	A. or P.	5.	See Note 3		12	18	
tPHL	A _i or B _i	Σί			11.5	18	ns ns
tPLH .	CO	C4			6	11	
ФHL.		C4	$C_{L} = 15 pF, R_{L} = 560 \Omega,$		7.5	11	ns
tPLH .	A. or B.	C4	See Note 3		7.5	12	
tPHL	A _i or B _i				8.5	12	ns

 $[\]P_{tPLH}$ = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $[\]dagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Only one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

tpHL = propagation delay time, high-to-low-level output



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-7604301VEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
76043012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7604301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7604301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/31202B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/31202BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/31202BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54LS283J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S283J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN74283N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS283D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS283N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS283NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS283NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS283NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S283D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74S283N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S283N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S283NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SNJ54LS283FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS283J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS283W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S283FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S283J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S283W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type



PACKAGE OPTION ADDENDUM

18-Sep-2008

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS283DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS283NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS283DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS283NSR	SO	NS	16	2000	346.0	346.0	33.0

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